









SNIS159H - AUGUST 1999 - REVISED DECEMBER 2017

LM35

LM35 Precision Centigrade Temperature Sensors

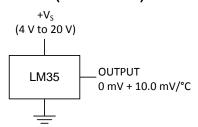
Features

- Calibrated Directly in Celsius (Centigrade)
- Linear + 10-mV/°C Scale Factor
- 0.5°C Ensured Accuracy (at 25°C)
- Rated for Full -55°C to 150°C Range
- Suitable for Remote Applications
- Low-Cost Due to Wafer-Level Trimming
- Operates From 4 V to 30 V
- Less Than 60-µA Current Drain
- Low Self-Heating, 0.08°C in Still Air
- Non-Linearity Only ±1/4°C Typical
- Low-Impedance Output, 0.1 Ω for 1-mA Load

Applications

- **Power Supplies**
- **Battery Management**
- **HVAC**
- **Appliances**

Basic Centigrade Temperature Sensor (2°C to 150°C)



3 Description

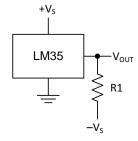
The LM35 series are precision integrated-circuit temperature devices with an output voltage linearlyproportional to the Centigrade temperature. The LM35 device has an advantage over linear temperature sensors calibrated in Kelvin, as the user is not required to subtract a large constant voltage from the output to obtain convenient Centigrade scaling. The LM35 device does not require any external calibration or trimming to provide typical accuracies of ±1/4°C at room temperature and ±3/4°C over a full -55°C to 150°C temperature range. Lower cost is assured by trimming and calibration at the wafer level. The low-output impedance, linear output, and precise inherent calibration of the LM35 device makes interfacing to readout or control circuitry especially easy. The device is used with single power supplies, or with plus and minus supplies. As the LM35 device draws only 60 µA from the supply, it has very low self-heating of less than 0.1°C in still air. The LM35 device is rated to operate over a -55°C to 150°C temperature range, while the LM35C device is rated for a -40°C to 110°C range (-10° with improved accuracy). The LM35-series devices are available packaged in hermetic TO transistor packages, while the LM35C, LM35CA, and LM35D devices are available in the plastic TO-92 transistor package. The LM35D device is available in an 8-lead surface-mount small-outline package and a plastic TO-220 package.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
	TO-CAN (3)	4.699 mm × 4.699 mm
LM35	TO-92 (3)	4.30 mm × 4.30 mm
	SOIC (8)	4.90 mm × 3.91 mm
	TO-220 (3)	14.986 mm × 10.16 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Full-Range Centigrade Temperature Sensor



Choose $R_1 = -V_S / 50 \mu A$ V_{OUT} = 1500 mV at 150°C V_{OUT} = 250 mV at 25°C $V_{OUT} = -550 \text{ mV at } -55^{\circ}\text{C}$



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 Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section 	N
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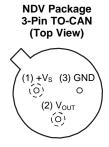
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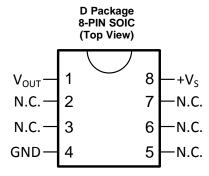
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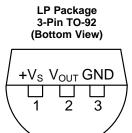
5 Pin Configuration and Functions

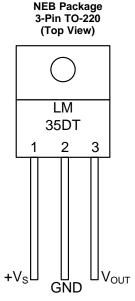


Case is connected to negative pin (GND) Refer the second NDV0003H page for reference



N.C. = No connection





Tab is connected to the negative pin (GND).

NOTE: The LM35DT pinout is different than the discontinued LM35DP

Pin Functions

	PIN					DESCRIPTION
NAME	TO46	TO92	TO220	SO8	TYPE	DESCRIPTION
V_{OUT}	2	2	3	1	0	Temperature Sensor Analog Output
N.C.	_	_	_	2		No Connection
N.C.			3	_	No Connection	
GND	3	3	2	4	GROUND	Device ground pin, connect to power supply negative terminal
	_	_	_	5		
N.C.	_	_	_	6	_	No Connection
	_	_	_	7		
+V _S	1	1	1	8	POWER	Positive power supply pin

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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)(2)

		MIN	MAX	UNIT
Supply voltage		-0.2	35	V
Output voltage		-1	6	V
Output current			10	mA
Maximum Junction Temperature, T _J m	ax		150	°C
Storogo Tomporatura T	TO-CAN, TO-92 Package	-60	150	°C
Storage Temperature, T _{stg}	TO-220, SOIC Package	-65	150	

⁽¹⁾ If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

6.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2500	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	LM35, LM35A	-55	150	
Specified operating temperature: T_{MIN} to T_{MAX}	LM35C, LM35CA	-40	110	°C
MAX	LM35D	0	100	
Supply Voltage (+V _S)		4	30	V

6.4 Thermal Information

		LM3	5		
THERMAL METRIC ⁽¹⁾⁽²⁾	NDV	LP	D	NEB	UNIT
	3 P	INS	8 PINS	3 PINS	
$R_{\theta JA}$ Junction-to-ambient thermal resistance	400	180	220	90	°C/W
R _{θJC(top)} Junction-to-case (top) thermal resistance	24	_	_	_	C/VV

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

⁽²⁾ Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

⁽²⁾ For additional thermal resistance information, see *Typical Application*.



6.5 Electrical Characteristics: LM35A, LM35CA Limits

Unless otherwise noted, these specifications apply: $-55^{\circ}C \le T_{J} \le 150^{\circ}C$ for the LM35 and LM35A; $-40^{\circ}C \le T_{J} \le 110^{\circ}C$ for the LM35C and LM35CA; and 0°C \leq T_J \leq 100°C for the LM35D. V_S = 5 Vdc and I_{LOAD} = 50 μ A, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

			LM35A			LM35CA		
PARAMETER	TEST CONDITIONS	TYP	TESTED LIMIT ⁽¹⁾	DESIGN LIMIT ⁽²⁾	TYP	TESTED LIMIT ⁽¹⁾	DESIGN LIMIT ⁽²⁾	UNIT
	T _A = 25°C	±0.2	±0.5		±0.2	±0.5		
Accuracy ⁽³⁾	$T_A = -10$ °C	±0.3			±0.3		±1	°C
Accuracy	$T_A = T_{MAX}$	±0.4	±1		±0.4	±1		
	$T_A = T_{MIN}$	±0.4	±1		±0.4		±1.5	
Nonlinearity (4)	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	±0.18		±0.35	±0.15		±0.3	°C
Sensor gain	$T_{MIN} \le T_A \le T_{MAX}$	10	9.9		10		9.9	mV/°C
(average slope)	-40°C ≤ T _J ≤ 125°C	10	10.1		10		10.1	IIIV/ C
Load regulation (5)	T _A = 25°C	±0.4	±1		±0.4	±1		
Load regulation $^{(5)}$ 0 \leq I _L \leq 1 mA	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	±0.5		±3	±0.5		±3	mV/mA
	T _A = 25°C	±0.01	±0.05		±0.01	±0.05		
Line regulation ⁽⁵⁾	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	±0.02		±0.1	±0.02		±0.1	mV/V
	V _S = 5 V, 25°C	56	67		56	67		
Outcoant ourrent(6)	V _S = 5 V, −40°C ≤ T _J ≤ 125°C	105		131	91		114	
Quiescent current	V _S = 30 V, 25°C	56.2	68		56.2	68		μA
Quiescent current ⁽⁶⁾	$V_S = 30 \text{ V}, -40^{\circ}\text{C} \le T_J \le 125^{\circ}\text{C}$	105.5		133	91.5		116	
Change of guiogoant	4 V ≤ V _S ≤ 30 V, 25°C	0.2	1		0.2	1		
Change of quiescent current ⁽⁵⁾	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	0.5		2	0.5		2	μA
Temperature coefficient of quiescent current	-40°C ≤ T _J ≤ 125°C	0.39		0.5	0.39		0.5	μΑ/°C
Minimum temperature for rate accuracy	In circuit of Figure 14, I _L = 0	1.5		2	1.5		2	°C
Long term stability	$T_J = T_{MAX}$, for 1000 hours	±0.08			±0.08			°C

- Tested Limits are ensured and 100% tested in production.
- Design Limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.
- Accuracy is defined as the error between the output voltage and 10 mv/°C times the case temperature of the device, at specified conditions of voltage, current, and temperature (expressed in °C).
- (4) Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the rated temperature range of the device.
- Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.

Product Folder Links: LM35

Quiescent current is defined in the circuit of Figure 14.



6.6 Electrical Characteristics: LM35A, LM35CA

Unless otherwise noted, these specifications apply: $-55^{\circ}\text{C} \le \text{T}_{\text{J}} \le 150^{\circ}\text{C}$ for the LM35 and LM35A; $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 110^{\circ}\text{C}$ for the LM35C and LM35CA; and $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 100^{\circ}\text{C}$ for the LM35D. $V_S = 5$ Vdc and $I_{\text{LOAD}} = 50~\mu\text{A}$, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

DADAMETER	TEST SS	NULTIONS		LM35A		L	M35CA		
PARAMETER	TEST CO	NDITIONS	MIN	TYP	MAX	TYP	TYP	MAX	UNIT
				±0.2			±0.2		
	T _A = 25°C	Tested Limit (2)			±0.5			±0.5	
		Design Limit ⁽³⁾							
				±0.3			±0.3		
l	$T_A = -10^{\circ}C$	Tested Limit (2)							
(4)		Design Limit ⁽³⁾						±1	
Accuracy ⁽¹⁾				±0.4			±0.4		°C
	$T_A = T_{MAX}$	Tested Limit (2)			±1			±1	
	A WAX	Design Limit ⁽³⁾							
		3 3		±0.4			±0.4		
	$T_A = T_{MIN}$	Tested Limit (2)			±1				
	A - IMIN	Design Limit ⁽³⁾						±1.5	
		2 co.g.:		±0.18			±0.15		
Nonlinearity (4)	$T_{MIN} \le T_A \le T_{MAX}$	Tested Limit (2)		20.10			20.10		°C
$-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$ $Design \ \text{Limit}^{(3)}$ ± 0.35		±0.3	O						
		Design Limit		10	10.00		10	±0.0	
	$T_{MIN} \le T_A \le T_{MAX}$	Tested Limit (2)		10	9.9		10		
	IMIN = IA = IMAX	Design Limit ⁽³⁾			3.3			9.9	
Sensor gain (average slope)		Design Limit		10			10	9.9	mV/°C
(areage orap e)	–40°C ≤ T _J ≤ 125°C	Tested Limit (2)		10	10.1		10		
	-40 C 3 1j 3 125 C	Design Limit ⁽³⁾			10.1			10.1	
		Design Limit		±0.4			±0.4	10.1	
	T _A = 25°C	Tested Limit (2)		±0.4	.1		±0.4	±1	
(5)	1A = 25 C	Design Limit ⁽³⁾			±1			±1	
Load regulation $^{(5)}$ 0 \leq I _L \leq 1 mA		Design Limit		.O. F			.0.5		mV/mA
0 = 1[= 1 1111/	$T_{MIN} \le T_A \le T_{MAX}$	Tested Limit (2)		±0.5			±0.5		
	-40°C ≤ T _J ≤ 125°C								
		Design Limit ⁽³⁾		0.04	±3		0.04	±3	
	T _A = 25°C	T (2)		±0.01	0.35		±0.01		
		Tested Limit ⁽²⁾			±0.05			±0.05	mV/V
Line regulation (5)		Design Limit ⁽³⁾							
-	4 V ≤ V _S ≤ 30 V,	(0)	1	±0.02			±0.02		
	$-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$	Tested Limit (2)							
		Design Limit ⁽³⁾			±0.1			±0.1	

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⁽¹⁾ Accuracy is defined as the error between the output voltage and 10 mv/°C times the case temperature of the device, at specified conditions of voltage, current, and temperature (expressed in °C).

⁽²⁾ Tested Limits are ensured and 100% tested in production.

⁽³⁾ Design Limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.

⁽⁴⁾ Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the rated temperature range of the device.

⁽⁵⁾ Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.



Electrical Characteristics: LM35A, LM35CA (continued)

Unless otherwise noted, these specifications apply: $-55^{\circ}C \le T_{J} \le 150^{\circ}C$ for the LM35 and LM35A; $-40^{\circ}C \le T_{J} \le 110^{\circ}C$ for the LM35C and LM35CA; and $0^{\circ}C \le T_{J} \le 100^{\circ}C$ for the LM35D. $V_{S} = 5$ Vdc and $I_{LOAD} = 50$ μ A, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

DADAMETER	TEST COMP	ITIONS		LM35A		L	М35СА		UNIT
PARAMETER	TEST COND	IIIONS	MIN	TYP	MAX	TYP	TYP	MAX	UNII
				56			56		
	V _S = 5 V, 25°C	Tested Limit (2)			67			67	
		Design Limit ⁽³⁾							
				105			91		
	$V_S = 5 V$, -40°C ≤ $T_J \le 125$ °C	Tested Limit (2)							
Quiescent	10 0 = 11 = 120 0	Design Limit ⁽³⁾			131			114	
current ⁽⁶⁾				56.2			56.2		μA
	V _S = 30 V, 25°C	Tested Limit (2)			68			68	
		Design Limit ⁽³⁾							
				105.5			91.5		
	$V_S = 30 \text{ V},$ -40°C \le T_1 \le 125°C	Tested Limit (2)							
	10 0 = 1j = 120 0	Design Limit ⁽³⁾			133			116	
				0.2			0.2		
	4 V ≤ V _S ≤ 30 V, 25°C	Tested Limit (2)			1			1	
Change of		Design Limit ⁽³⁾							
quiescent current ⁽⁵⁾				0.5			0.5		μA
	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	Tested Limit (2)							
	10 0 = 1j = 120 0	Tested Limit (2)							
Temperature				0.39			0.39		
coefficient of	–40°C ≤ T _J ≤ 125°C	Tested Limit (2)							μΑ/°C
quiescent current		Design Limit ⁽³⁾			0.5			0.5	
Minimum				1.5			1.5		
temperature for	In circuit of Figure 14, I _L = 0	Tested Limit (2)							°C
rate accuracy		Design Limit ⁽³⁾			2			2	
Long term stability	$T_J = T_{MAX}$, for 1000 hours			±0.08			±0.08		°C

⁽⁶⁾ Quiescent current is defined in the circuit of Figure 14.



6.7 Electrical Characteristics: LM35, LM35C, LM35D Limits

Unless otherwise noted, these specifications apply: $-55^{\circ}\text{C} \le \text{T}_{\text{J}} \le 150^{\circ}\text{C}$ for the LM35 and LM35A; $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 110^{\circ}\text{C}$ for the LM35C and LM35CA; and $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 100^{\circ}\text{C}$ for the LM35D. $V_S = 5$ Vdc and $I_{\text{LOAD}} = 50~\mu\text{A}$, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

			LM35		L	M35C, LM3	5D	
PARAMETER	TEST CONDITIONS	TYP	TESTED LIMIT ⁽¹⁾	DESIGN LIMIT ⁽²⁾	TYP	TESTED LIMIT ⁽¹⁾	DESIGN LIMIT ⁽²⁾	UNIT
	$T_A = 25$ °C	±0.4	±1		±0.4	±1		
Accuracy, LM35,	$T_A = -10^{\circ}C$	±0.5			±0.5		±1.5	°C
LM35C ⁽³⁾	$T_A = T_{MAX}$	±0.8	±1.5		±0.8		±1.5	
	$T_A = T_{MIN}$	±0.8		±1.5	±0.8		±2	
	T _A = 25°C				±0.6	±1.5		
Accuracy, LM35D (3)	$T_A = T_{MAX}$				±0.9		±2	°C
	$T_A = T_{MIN}$				±0.9		±2	
Nonlinearity (4)	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	±0.3		±0.5	±0.2		±0.5	°C
Sensor gain	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	10	9.8		10		9.8	mV/°C
(average slope)		10	10.2		10		DESIGN LIMIT(2) 1	
Load regulation ⁽⁵⁾ 0 ≤ I _L ≤ 1 mA	T _A = 25°C	±0.4	±2		±0.4	±2		mV/mA
	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	±0.5		±5	±0.5		±5	
	T _A = 25°C	±0.01	±0.1		±0.01	±0.1		
Line regulation (5)	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	±0.02		±0.2	±0.02		±0.2	mV/V
	V _S = 5 V, 25°C	56	80		56	80		
Quiescent current ⁽⁶⁾	V _S = 5 V, -40°C ≤ T _J ≤ 125°C	105		158	91		138	
Quiescent current(4)	V _S = 30 V, 25°C	56.2	82		56.2	82		μA
	$V_S = 30 \text{ V}, -40^{\circ}\text{C} \le T_J \le 125^{\circ}\text{C}$	105.5		161	91.5		141	
Change of guinesant	4 V ≤ V _S ≤ 30 V, 25°C	0.2	2		0.2	2		
Change of quiescent current (5)	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	0.5		3	0.5		3	μA
Temperature coefficient of quiescent current	-40°C ≤ T _J ≤ 125°C	0.39		0.7	0.39		0.7	μΑ/°C
Minimum temperature for rate accuracy	In circuit of Figure 14, I _L = 0	1.5		2	1.5		2	°C
Long term stability	$T_J = T_{MAX}$, for 1000 hours	±0.08			±0.08			°C

- (1) Tested Limits are ensured and 100% tested in production.
- (2) Design Limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.
- (3) Accuracy is defined as the error between the output voltage and 10 mv/°C times the case temperature of the device, at specified conditions of voltage, current, and temperature (expressed in °C).
- (4) Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the rated temperature range of the device.
- (5) Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.
- (6) Quiescent current is defined in the circuit of Figure 14.



6.8 Electrical Characteristics: LM35, LM35C, LM35D

Unless otherwise noted, these specifications apply: $-55^{\circ}\text{C} \le \text{T}_{\text{J}} \le 150^{\circ}\text{C}$ for the LM35 and LM35A; $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 110^{\circ}\text{C}$ for the LM35C and LM35CA; and $0^{\circ}\text{C} \le \text{T}_{\text{J}} \le 100^{\circ}\text{C}$ for the LM35D. $V_S = 5$ Vdc and $I_{\text{LOAD}} = 50~\mu\text{A}$, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

DADAMETER	TEAT OF		LM35		LM3	LINIT			
PARAMETER	TEST CO	NDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
				±0.4			±0.4		
	T _A = 25°C	Tested Limit ⁽²⁾			±1			±1	
		Design Limit (3)							
				±0.5		·	±0.5		
	$T_A = -10$ °C	Tested Limit ⁽²⁾							
Accuracy, LM35,		Design Limit ⁽³⁾				·		±1.5	°C
Accuracy, LM35, _M35C ⁽¹⁾				±0.8		·	±0.8		
	$T_A = T_{MAX}$	Tested Limit ⁽²⁾			±1.5	·			
		Design Limit ⁽³⁾						±1.5	
				±0.8			±0.8		
	$T_A = T_{MIN}$	Tested Limit ⁽²⁾							
		Design Limit ⁽³⁾			±1.5	·		±2	
Accuracy, LM35D ⁽¹⁾							±0.6		
	T _A = 25°C	Tested Limit ⁽²⁾						±1.5	
		Design Limit ⁽³⁾							
						·	±0.9		°C
	$T_A = T_{MAX}$	Tested Limit ⁽²⁾				·			
LINIOOD		Design Limit ⁽³⁾						±2	
							±0.9		
	$T_A = T_{MIN}$	Tested Limit ⁽²⁾							
		Design Limit ⁽³⁾				·		±2	
	$T_{MIN} \le T_A \le T_{MAX}$, -40°C \le T _J \le 125°C			±0.3		·	±0.2		
Nonlinearity (4)		Tested Limit ⁽²⁾							°C
		Design Limit ⁽³⁾			±0.5	·		±0.5	
				10		·	10		
	$T_{MIN} \le T_A \le T_{MAX}$, -40°C \le T_J \le 125°C	Tested Limit ⁽²⁾			9.8				
Sensor gain	10 0 = 11 = 120 0	Design Limit ⁽³⁾						9.8	mV/°C
(average slope)				10			10		IIIV/ C
		Tested Limit ⁽²⁾			10.2	·			
		Design Limit ⁽³⁾				·		10.2	
				±0.4			±0.4		
	T _A = 25°C	Tested Limit ⁽²⁾			±2			±2	
_oad regulation (5)		Design Limit ⁽³⁾							1
$0 \le I_L \le 1 \text{ mA}$				±0.5			±0.5		mV/m/
	$T_{MIN} \le T_A \le T_{MAX},$ -40°C \le T_J \le 125°C	Tested Limit ⁽²⁾							
	.5 0 = .5 = 120 0	Design Limit ⁽³⁾			±5			±5	

⁽¹⁾ Accuracy is defined as the error between the output voltage and 10 mv/°C times the case temperature of the device, at specified conditions of voltage, current, and temperature (expressed in °C).

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⁽²⁾ Tested Limits are ensured and 100% tested in production.

⁽³⁾ Design Limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.

⁽⁴⁾ Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the rated temperature range of the device.

⁽⁵⁾ Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.



Electrical Characteristics: LM35, LM35C, LM35D (continued)

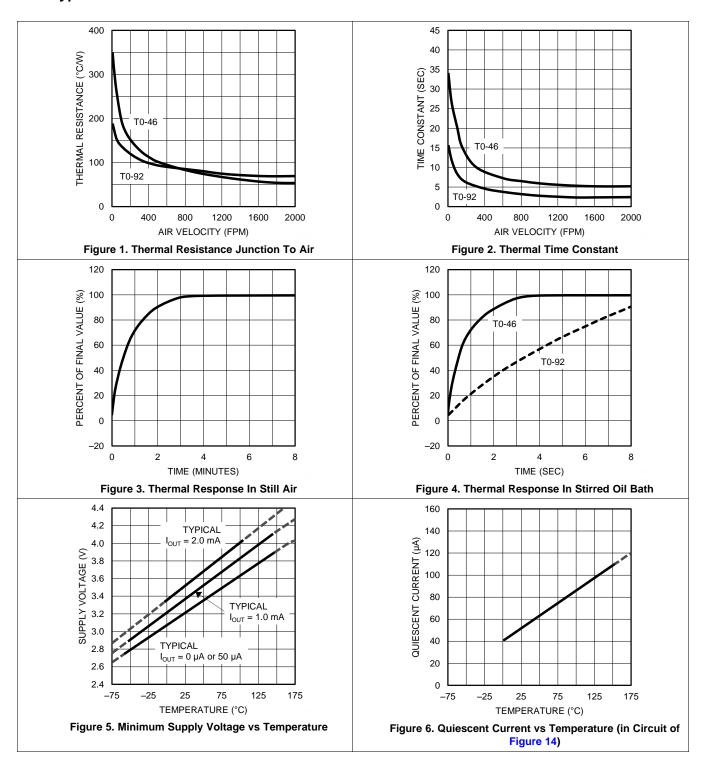
Unless otherwise noted, these specifications apply: $-55^{\circ}C \le T_{J} \le 150^{\circ}C$ for the LM35 and LM35A; $-40^{\circ}C \le T_{J} \le 110^{\circ}C$ for the LM35C and LM35CA; and $0^{\circ}C \le T_{J} \le 100^{\circ}C$ for the LM35D. $V_{S} = 5$ Vdc and $I_{LOAD} = 50$ μ A, in the circuit of Full-Range Centigrade Temperature Sensor. These specifications also apply from 2°C to T_{MAX} in the circuit of Figure 14.

DARAMETER	TEST COND	TIONS		LM35		LM3	LINUT				
PARAMETER	TEST CONDI	IIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT		
				±0.01			±0.01				
	T _A = 25°C	Tested Limit ⁽²⁾			±0.1	·					
(5)		Design Limit ⁽³⁾				·		±0.1			
ine regulation (5)				±0.02		·	±0.02		mV/V		
	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	Tested Limit (2)									
	-40 C = 1] = 125 C	Design Limit ⁽³⁾			±0.2			±0.2			
				56		·	56				
	V _S = 5 V, 25°C	Tested Limit ⁽²⁾			80			80			
Quiescent current ⁽⁶⁾		Design Limit ⁽³⁾				·					
				105		·	91				
	$V_S = 5 \text{ V}, -40^{\circ}\text{C} \le T_J \le 125^{\circ}\text{C}$	Tested Limit ⁽²⁾				·			μА		
		Design Limit ⁽³⁾			158	·		138			
				56.2		·	56.2				
	V _S = 30 V, 25°C	Tested Limit ⁽²⁾			82	·		82			
		Design Limit ⁽³⁾				·					
				105.5		·	91.5				
	$V_S = 30 \text{ V},$ -40°C \le T_J \le 125°C	Tested Limit ⁽²⁾				·					
	-40 0 ± 1j ± 125 0	Design Limit ⁽³⁾			161	·		141			
				0.2		·	0.2				
	4 V ≤ V _S ≤ 30 V, 25°C	Tested Limit ⁽²⁾				·		2			
Change of		Design Limit ⁽³⁾			2	·					
quiescent current ⁽⁵⁾				0.5		·	0.5		μΑ		
	4 V ≤ V _S ≤ 30 V, -40°C ≤ T _J ≤ 125°C	Tested Limit ⁽²⁾				·					
	-40 0 ± 1j ± 125 0	Design Limit ⁽³⁾			3	·		3			
Temperature				0.39		·	0.39				
coefficient of	-40°C ≤ T _J ≤ 125°C	Tested Limit ⁽²⁾	Fested Limit (2)					μΑ/°C			
quiescent current		Design Limit ⁽³⁾			0.7		0.5 3 0.39				
Minimum				1.5			1.5				
temperature for	In circuit of Figure 14, $I_L = 0$	Tested Limit ⁽²⁾						°C			
rate accuracy		Design Limit ⁽³⁾			2			2			
Long term stability	$T_J = T_{MAX}$, for 1000 hours			±0.08		·	±0.08		°C		

⁽⁶⁾ Quiescent current is defined in the circuit of Figure 14.



6.9 Typical Characteristics



TEXAS INSTRUMENTS

Typical Characteristics (continued)

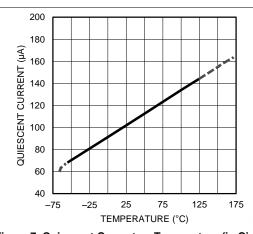


Figure 7. Quiescent Current vs Temperature (in Circuit of Full-Range Centigrade Temperature Sensor)

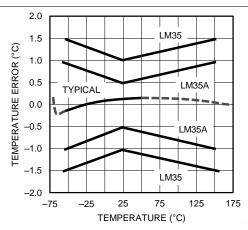


Figure 8. Accuracy vs Temperature (Ensured)

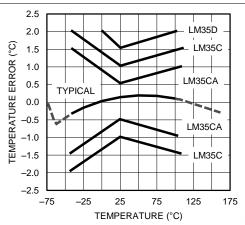


Figure 9. Accuracy vs Temperature (Ensured)

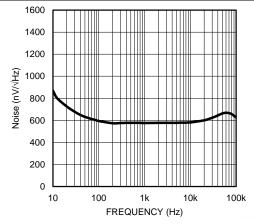


Figure 10. Noise Voltage

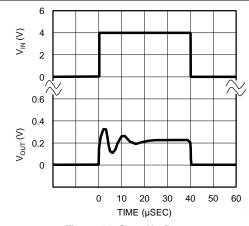


Figure 11. Start-Up Response



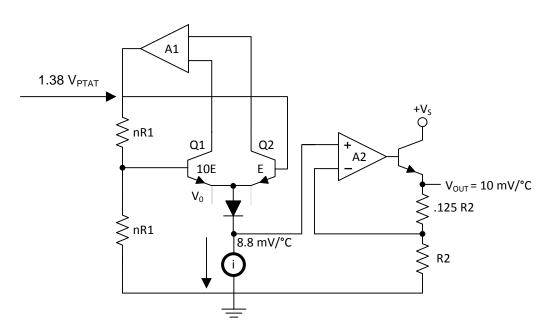
7 Detailed Description

7.1 Overview

The LM35-series devices are precision integrated-circuit temperature sensors, with an output voltage linearly proportional to the Centigrade temperature. The LM35 device has an advantage over linear temperature sensors calibrated in Kelvin, as the user is not required to subtract a large constant voltage from the output to obtain convenient Centigrade scaling. The LM35 device does not require any external calibration or trimming to provide typical accuracies of \pm ½ °C at room temperature and \pm ¾ °C over a full -55°C to 150°C temperature range. Lower cost is assured by trimming and calibration at the wafer level. The low output impedance, linear output, and precise inherent calibration of the LM35 device makes interfacing to readout or control circuitry especially easy. The device is used with single power supplies, or with plus and minus supplies. As the LM35 device draws only 60 μ A from the supply, it has very low self-heating of less than 0.1°C in still air. The LM35 device is rated to operate over a -55°C to 150°C temperature range, while the LM35C device is rated for a -40°C to 110°C range (-10° with improved accuracy). The temperature-sensing element is comprised of a delta-V BE architecture.

The temperature-sensing element is then buffered by an amplifier and provided to the VOUT pin. The amplifier has a simple class A output stage with typical $0.5-\Omega$ output impedance as shown in the *Functional Block Diagram*. Therefore the LM35 can only source current and it's sinking capability is limited to 1 μ A.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 LM35 Transfer Function

The accuracy specifications of the LM35 are given with respect to a simple linear transfer function:

$$V_{OUT} = 10 \text{ mv/}^{\circ}\text{C} \times \text{T}$$

where

V_{OUT} is the LM35 output voltage

7.4 Device Functional Modes

The only functional mode of the LM35 is that it has an analog output directly proportional to temperature.

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8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The features of the LM35 make it suitable for many general temperature sensing applications. Multiple package options expand on it's flexibility.

8.1.1 Capacitive Drive Capability

Like most micropower circuits, the LM35 device has a limited ability to drive heavy capacitive loads. Alone, the LM35 device is able to drive 50 pF without special precautions. If heavier loads are anticipated, isolating or decoupling the load with a resistor is easy (see Figure 12). The tolerance of capacitance can be improved with a series R-C damper from output to ground (see Figure 13).

When the LM35 device is applied with a $200-\Omega$ load resistor as shown in Figure 16, Figure 17, or Figure 19, the device is relatively immune to wiring capacitance because the capacitance forms a bypass from ground to input and not on the output. However, as with any linear circuit connected to wires in a hostile environment, performance is affected adversely by intense electromagnetic sources (such as relays, radio transmitters, motors with arcing brushes, and SCR transients), because the wiring acts as a receiving antenna and the internal junctions act as rectifiers. For best results in such cases, a bypass capacitor from V_{IN} to ground and a series R-C damper, such as 75 Ω in series with 0.2 or 1 μ F from output to ground, are often useful. Examples are shown in Figure 13, Figure 24, and Figure 25.



Figure 12. LM35 with Decoupling from Capacitive Load

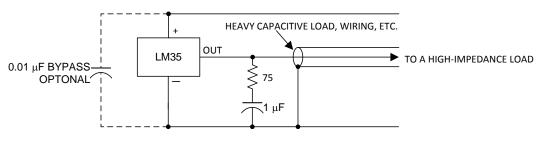


Figure 13. LM35 with R-C Damper



8.2 Typical Application

8.2.1 Basic Centigrade Temperature Sensor

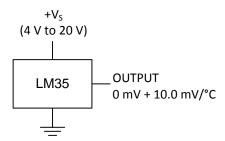


Figure 14. Basic Centigrade Temperature Sensor (2 °C to 150 °C)

8.2.1.1 Design Requirements

Table 1. Design Parameters

PARAMETER	VALUE
Accuracy at 25°C	±0.5°C
Accuracy from -55 °C to 150°C	±1°C
Temperature Slope	10 mV/°C

8.2.1.2 Detailed Design Procedure

Because the LM35 device is a simple temperature sensor that provides an analog output, design requirements related to layout are more important than electrical requirements. For a detailed description, refer to the *Layout*.

8.2.1.3 Application Curve

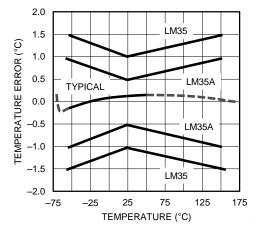


Figure 15. Accuracy vs Temperature (Ensured)

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8.3 System Examples



Figure 16. Two-Wire Remote Temperature Sensor (Grounded Sensor)

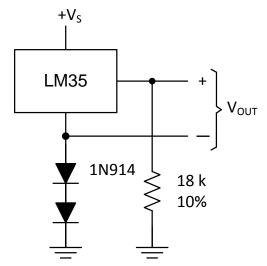


Figure 18. Temperature Sensor, Single Supply (-55° to +150°C)

Figure 17. Two-Wire Remote Temperature Sensor (Output Referred to Ground)

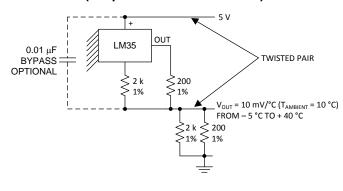
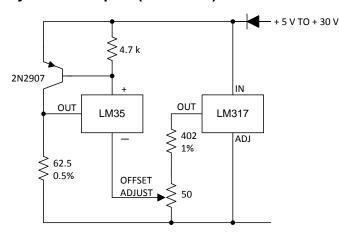


Figure 19. Two-Wire Remote Temperature Sensor (Output Referred to Ground)



System Examples (continued)



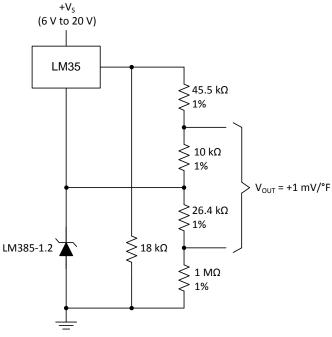


Figure 20. 4-To-20 mA Current Source (0°C to 100°C)



Figure 22. Centigrade Thermometer (Analog Meter)

Figure 21. Fahrenheit Thermometer

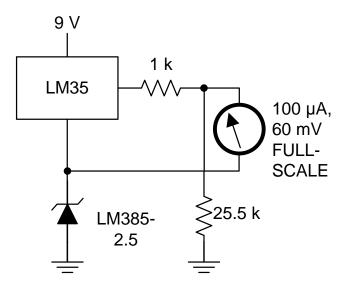


Figure 23. Fahrenheit Thermometer, Expanded Scale Thermometer (50°F to 80°F, for Example Shown)



System Examples (continued)



Figure 24. Temperature to Digital Converter (Serial Output) (128°C Full Scale)

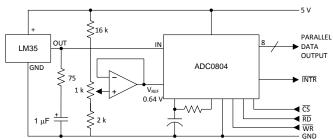
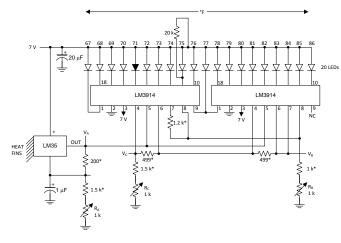
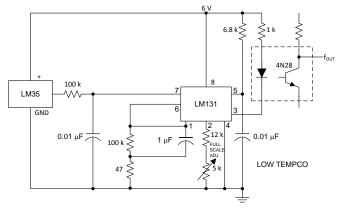


Figure 25. Temperature to Digital Converter (Parallel TRI-STATE Outputs for Standard Data Bus to μP Interface) (128°C Full Scale)





*=1% or 2% film resistor

Trim R_B for $V_B = 3.075 \text{ V}$

Trim R_C for $V_C = 1.955 V$

Trim R_A for $V_A = 0.075 \text{ V} + 100 \text{ mV/°C } \times T_{ambient}$

Example, $V_A = 2.275 \text{ V}$ at 22°C

Figure 26. Bar-Graph Temperature Display (Dot Mode)

Figure 27. LM35 With Voltage-To-Frequency Converter and Isolated Output (2°C to 150°C; 20 to 1500 Hz)



9 Power Supply Recommendations

The LM35 device has a very wide 4-V to 30-V power supply voltage range, which makes it ideal for many applications. In noisy environments, TI recommends adding a 0.1 μ F from V+ to GND to bypass the power supply voltage. Larger capacitances maybe required and are dependent on the power-supply noise.

10 Layout

10.1 Layout Guidelines

The LM35 is easily applied in the same way as other integrated-circuit temperature sensors. Glue or cement the device to a surface and the temperature should be within about 0.01°C of the surface temperature.

The 0.01°C proximity presumes that the ambient air temperature is almost the same as the surface temperature. If the air temperature were much higher or lower than the surface temperature, the actual temperature of the LM35 die would be at an intermediate temperature between the surface temperature and the air temperature; this is especially true for the TO-92 plastic package. The copper leads in the TO-92 package are the principal thermal path to carry heat into the device, so its temperature might be closer to the air temperature than to the surface temperature.

Ensure that the wiring leaving the LM35 device is held at the same temperature as the surface of interest to minimize the temperature problem. The easiest fix is to cover up these wires with a bead of epoxy. The epoxy bead will ensure that the leads and wires are all at the same temperature as the surface, and that the temperature of the LM35 die is not affected by the air temperature.

The TO-46 metal package can also be soldered to a metal surface or pipe without damage. Of course, in that case the V- terminal of the circuit will be grounded to that metal. Alternatively, mount the LM35 inside a sealed-end metal tube, and then dip into a bath or screw into a threaded hole in a tank. As with any IC, the LM35 device and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as a conformal coating and epoxy paints or dips are often used to insure that moisture cannot corrode the LM35 device or its connections.

These devices are sometimes soldered to a small light-weight heat fin to decrease the thermal time constant and speed up the response in slowly-moving air. On the other hand, a small thermal mass may be added to the sensor, to give the steadiest reading despite small deviations in the air temperature.

<u>-</u>	шин = 1 - 1 - 1 - 1 - 1 - 1			· · · · · · · · · · · · · · · · · · ·		,	JA/
	TO, no heat sink	TO ⁽¹⁾ , small heat fin	TO-92, no heat sink	TO-92 ⁽²⁾ , small heat fin	SOIC-8, no heat sink	SOIC-8 ⁽²⁾ , small heat fin	TO-220, no heat sink
Still air	400°C/W	100°C/W	180°C/W	140°C/W	220°C/W	110°C/W	90°C/W
Moving air	100°C/W	40°C/W	90°C/W	70°C/W	105°C/W	90°C/W	26°C/W
Still oil	100°C/W	40°C/W	90°C/W	70°C/W	_	_	_
Stirred oil	50°C/W	30°C/W	45°C/W	40°C/W	_	_	_
(Clamped to metal, Infinite heat sink)	(24°C/W)		_	_	(55°C/W)		_

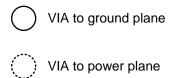
Table 2. Temperature Rise of LM35 Due To Self-heating (Thermal Resistance, Raja)

⁽¹⁾ Wakefield type 201, or 1-in disc of 0.02-in sheet brass, soldered to case, or similar.

⁽²⁾ TO-92 and SOIC-8 packages glued and leads soldered to 1-in square of 1/16-in printed circuit board with 2-oz foil or similar.



10.2 Layout Example



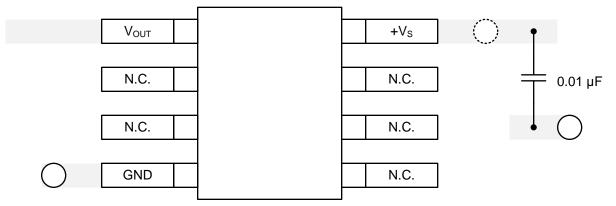


Figure 28. Layout Example



11 Device and Documentation Support

11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on A*lert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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7-May-2025

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
LM35AH	Active	Production	TO (NDV) 3	500 SMALL T&R	No	Call TI	Level-1-NA-UNLIM	-55 to 150	(LM35AH, LM35AH)
LM35AH/NOPB	Active	Production	TO (NDV) 3	500 SMALL T&R	Yes	Call TI	Level-1-NA-UNLIM	-55 to 150	(LM35AH, LM35AH)
LM35CAH	Active	Production	TO (NDV) 3	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM35CAH, LM35CAH)
LM35CAH/NOPB	Active	Production	TO (NDV) 3	500 SMALL T&R	Yes	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM35CAH, LM35CAH)
LM35CAZ/LFT4	Active	Production	TO-92 (LP) 3	2000 LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM35 CAZ
LM35CAZ/NOPB	Active	Production	TO-92 (LP) 3	1800 BULK	Yes	SN	N/A for Pkg Type	-40 to 110	LM35 CAZ
LM35CH	Active	Production	TO (NDV) 3	500 OTHER	No	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM35CH, LM35CH)
LM35CH/NOPB	Active	Production	TO (NDV) 3	500 SMALL T&R	Yes	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM35CH, LM35CH)
LM35CZ/LFT1	Active	Production	TO-92 (LP) 3	2000 LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM35 CZ
LM35CZ/NOPB	Active	Production	TO-92 (LP) 3	1800 BULK	Yes	SN	N/A for Pkg Type	-40 to 110	LM35 CZ
LM35DH	Active	Production	TO (NDV) 3	1000 SMALL T&R	No	Call TI	Level-1-NA-UNLIM	0 to 70	(LM35DH, LM35DH)
LM35DH/NOPB	Active	Production	TO (NDV) 3	1000 SMALL T&R	Yes	Call TI	Level-1-NA-UNLIM	0 to 70	(LM35DH, LM35DH)
LM35DM	Last Time Buy	Production	SOIC (D) 8	95 TUBE	No	Call TI	Level-1-235C-UNLIM	0 to 100	LM35D M
LM35DMX	NRND	Production	SOIC (D) 8	2500 LARGE T&R	No	Call TI	Level-1-235C-UNLIM	0 to 100	LM35D M
LM35DMX/NOPB	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 100	LM35D M
LM35DT	NRND	Production	TO-220 (NEB) 3	45 TUBE	No	Call TI	Level-1-NA-UNLIM	0 to 100	LM35DT
LM35DT/NOPB	Active	Production	TO-220 (NEB) 3	45 TUBE	Yes	SN	Level-1-NA-UNLIM	0 to 100	LM35DT
LM35DZ/LFT1	Active	Production	TO-92 (LP) 3	2000 LARGE T&R	Yes	SN	N/A for Pkg Type	-	LM35 DZ
LM35DZ/LFT4	Active	Production	TO-92 (LP) 3	2000 AMMO	Yes	SN	N/A for Pkg Type	-	LM35 DZ
LM35DZ/NOPB	Active	Production	TO-92 (LP) 3	1800 BULK	Yes	SN	N/A for Pkg Type	0 to 100	LM35 DZ

PACKAGE OPTION ADDENDUM

www.ti.com 7-May-2025

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
LM35H	Active	Production	TO (NDV) 3	500 SMALL T&R	No	Call TI	(5) Level-1-NA-UNLIM	-55 to 150	(LM35H, LM35H)
LM35H/NOPB	Active	Production	TO (NDV) 3	500 SMALL T&R	Yes	Call TI	Level-1-NA-UNLIM	-55 to 150	(LM35H, LM35H)

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

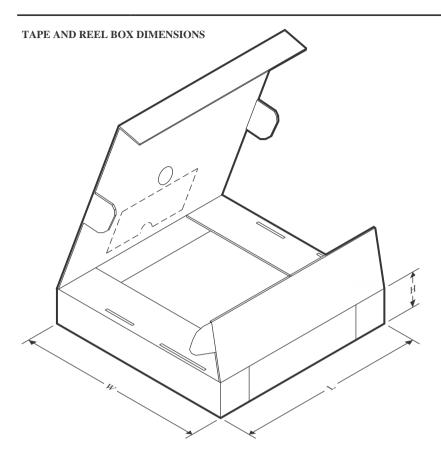


*All dimensions are nominal

Device	_	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM35DMX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM35DMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM35DMX	SOIC	D	8	2500	367.0	367.0	35.0
LM35DMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

PACKAGE MATERIALS INFORMATION

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TUBE

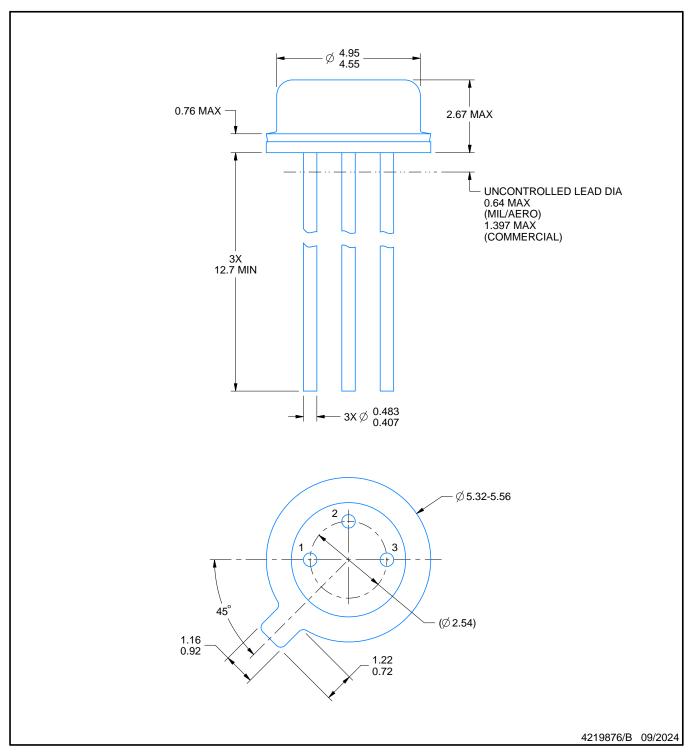


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LM35DM	D	SOIC	8	95	495	8	4064	3.05
LM35DM	D	SOIC	8	95	495	8	4064	3.05
LM35DT	NEB	TO-220	3	45	502	33	6985	4.06
LM35DT	NEB	TO-220	3	45	502	33	6985	4.06
LM35DT/NOPB	NEB	TO-220	3	45	502	33	6985	4.06



TRANSISTOR OUTLINE

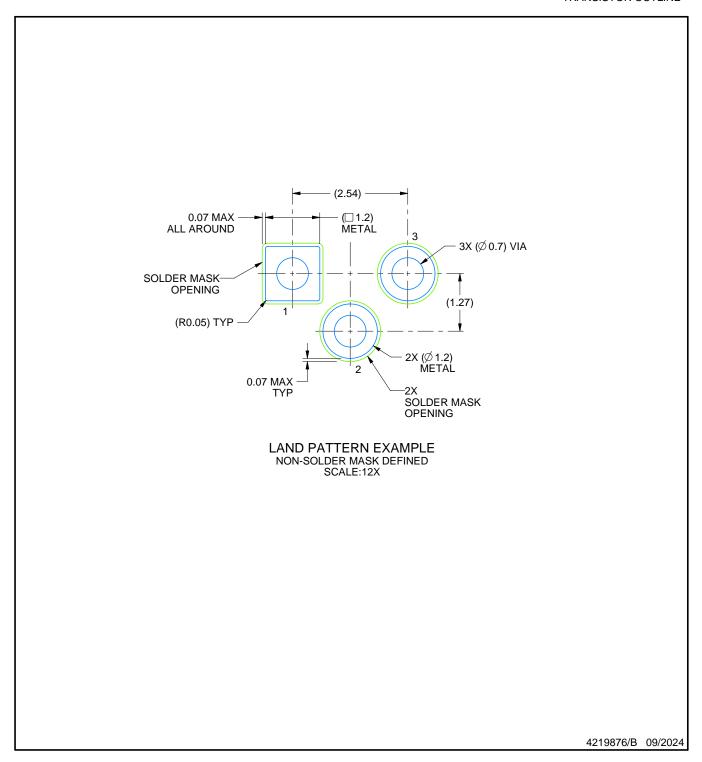


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing All linear differsions are in minimeters. Any difference per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC registration TO-46.



TRANSISTOR OUTLINE





SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



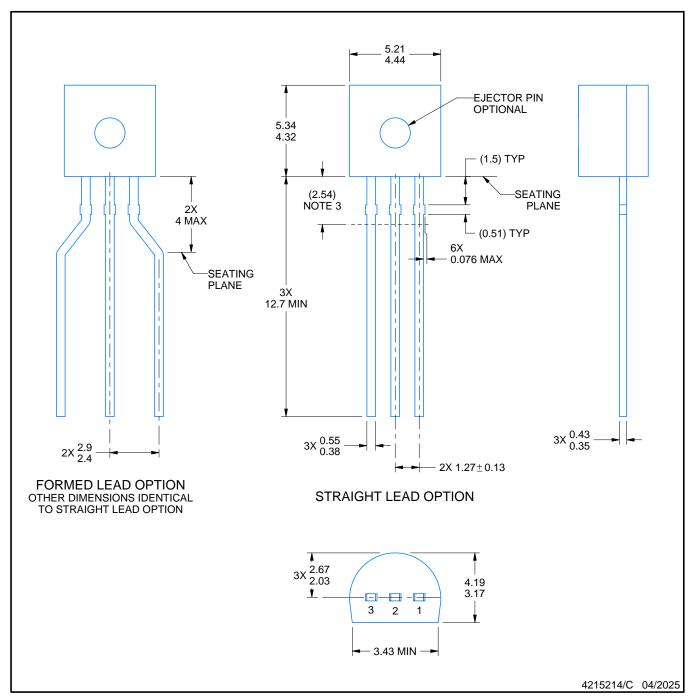
NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



TO-92 - 5.34 mm max height

TO-92



NOTES:

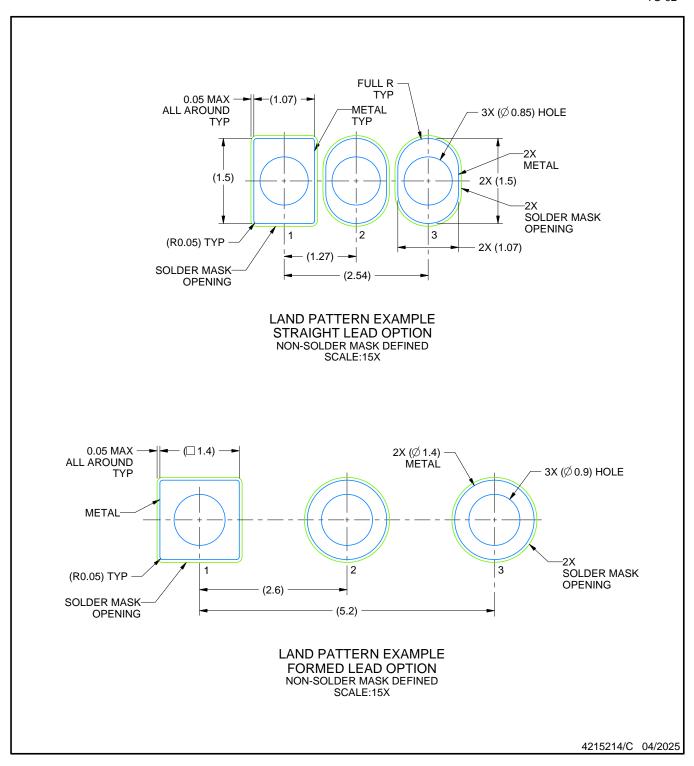
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.
- 3. Lead dimensions are not controlled within this area. 4. Reference JEDEC TO-226, variation AA.
- 5. Shipping method:

 - a. Straight lead option available in bulk pack only.
 b. Formed lead option available in tape and reel or ammo pack.
 - c. Specific products can be offered in limited combinations of shipping medium and lead options.
 - d. Consult product folder for more information on available options.

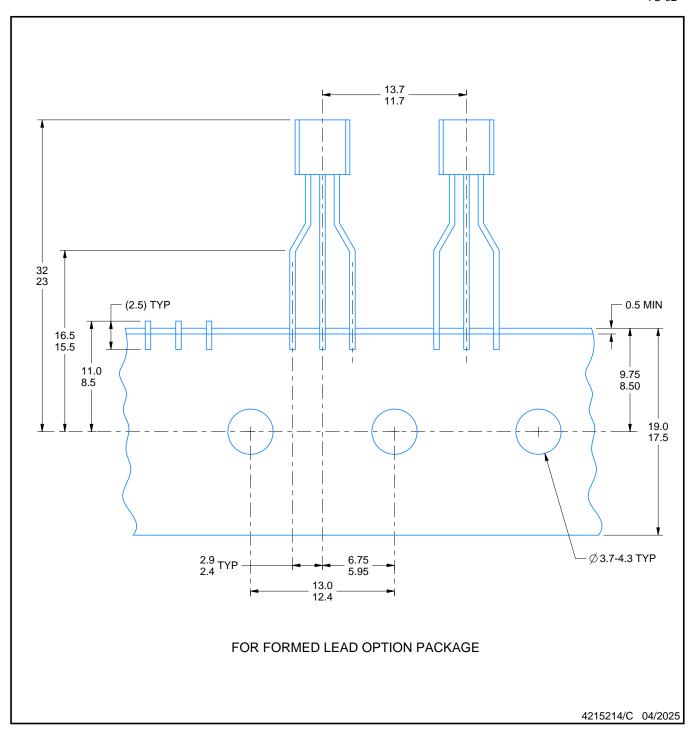


TO-92





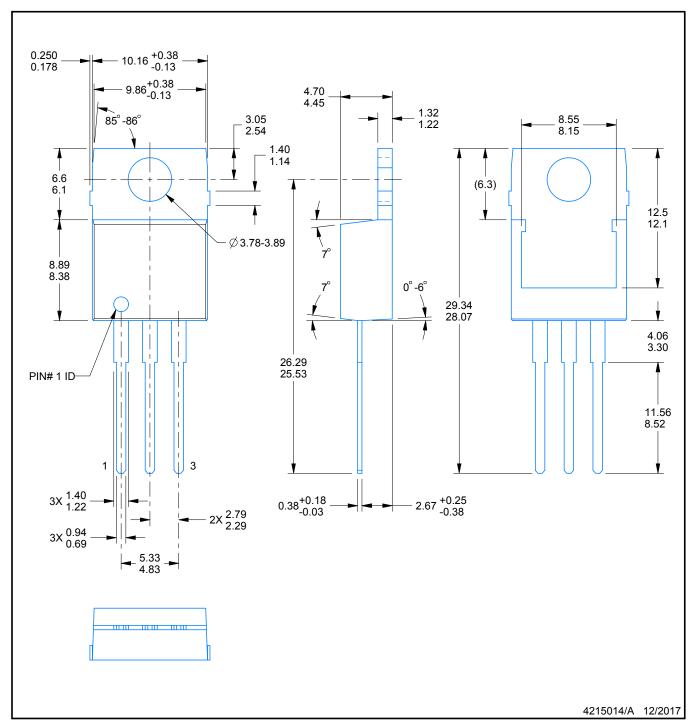
TO-92







TRANSISTOR OUTLINE

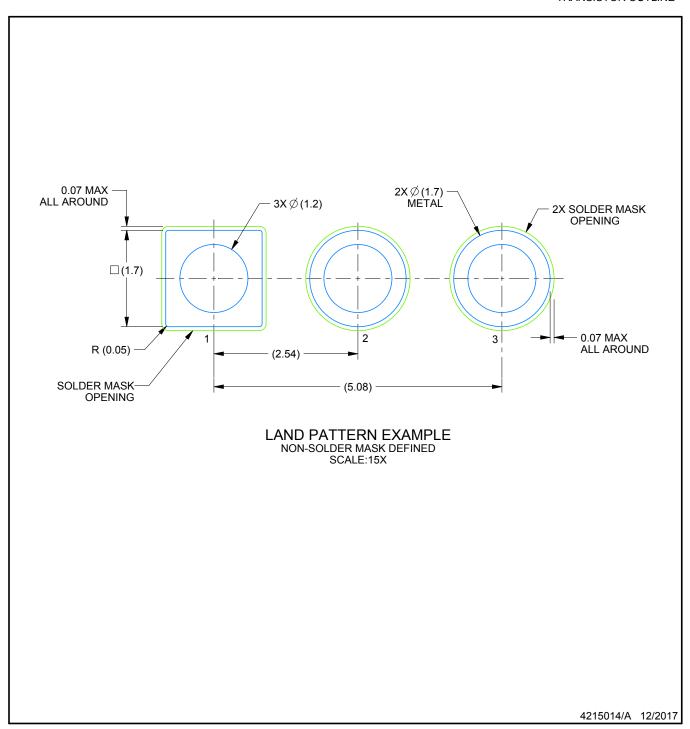


NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
 Reference JEDEC registration TO-220.



TRANSISTOR OUTLINE



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